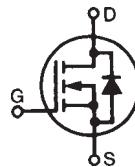
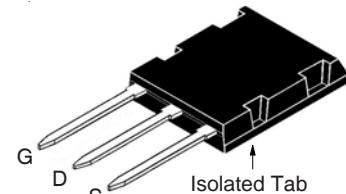


**Polar3™ HiPerFET™  
Power MOSFET**
**IXFL132N50P3**
**(Electrically Isolated Tab)**

N-Channel Enhancement Mode  
Avalanche Rated  
Fast Intrinsic Rectifier



**$V_{DSS}$**  = 500V  
 **$I_{D25}$**  = 63A  
 **$R_{DS(on)}$**  ≤ 43mΩ  
 **$t_{rr}$**  ≤ 250ns

**ISOPLUS264**


G = Gate      D = Drain  
S = Source

Symbol	Test Conditions	Maximum Ratings	
$V_{DSS}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$	500	V
$V_{DGR}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$ , $R_{GS} = 1\text{M}\Omega$	500	V
$V_{GSS}$	Continuous	±30	V
$V_{GSM}$	Transient	±40	V
$I_{D25}$	$T_C = 25^\circ\text{C}$	63	A
$I_{DM}$	$T_C = 25^\circ\text{C}$ , Pulse Width Limited by $T_{JM}$	330	A
$I_A$	$T_C = 25^\circ\text{C}$	66	A
$E_{AS}$	$T_C = 25^\circ\text{C}$	3	J
$dv/dt$	$I_S \leq I_{DM}$ , $V_{DD} \leq V_{DSS}$ , $T_J \leq 150^\circ\text{C}$	35	V/ns
$P_D$	$T_C = 25^\circ\text{C}$	520	W
$T_J$		-55 ... +150	°C
$T_{JM}$		150	°C
$T_{stg}$		-55 ... +150	°C
$T_L$	1.6mm (0.062 in.) from Case for 10s	300	°C
$T_{SOLD}$	Plastic Body for 10s	260	°C
$F_c$	Mounting Force	40..120 / 9..27	N/lb.
$V_{ISOL}$	50/60 Hz, RMS $t = 1\text{ min}$ $I_{ISOL} \leq 1\text{ mA}$ $t = 1\text{ s}$	2500 3000	V~
<b>Weight</b>		8	g

Symbol	Test Conditions ( $T_J = 25^\circ\text{C}$ Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
$BV_{DSS}$	$V_{GS} = 0\text{V}$ , $I_D = 3\text{mA}$	500		V
$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 8\text{mA}$	3.0		V
$I_{GSS}$	$V_{GS} = \pm 30\text{V}$ , $V_{DS} = 0\text{V}$			±200 nA
$I_{DSS}$	$V_{DS} = V_{DSS}$ , $V_{GS} = 0\text{V}$ $T_J = 125^\circ\text{C}$			50 μA 6 mA
$R_{DS(on)}$	$V_{GS} = 10\text{V}$ , $I_D = 66\text{A}$ , Note 1			43 mΩ

**Features**

- Silicon Chip on Direct-Copper-Bond Substrate
  - High Power Dissipation
  - Isolated Mounting Surface
  - 2500V Electrical Isolation
- Avalanche Rated
- Low Package Inductance
- Fast Intrinsic Rectifier
- Low  $R_{DS(on)}$  and  $Q_G$

**Advantages**

- Easy to Mount
- Space Savings

**Applications**

- DC-DC Converters
- Battery Chargers
- Switch-Mode and Resonant-Mode Power Supplies
- Uninterrupted Power Supplies
- AC Motor Drives
- High Speed Power Switching Applications

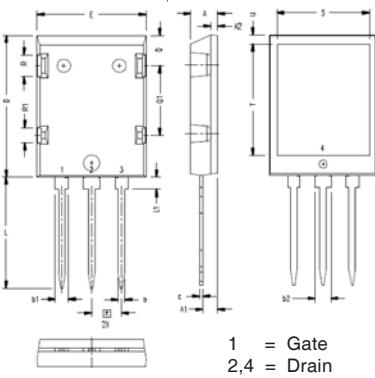
Symbol	Test Conditions (T <sub>J</sub> = 25°C Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
<b>g<sub>fs</sub></b>	V <sub>DS</sub> = 10V, I <sub>D</sub> = 66A, Note 1	68	115	S
<b>C<sub>iss</sub></b>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 25V, f = 1MHz	18.6		nF
<b>C<sub>oss</sub></b>		1750		pF
<b>C<sub>rss</sub></b>		5.0		pF
<b>R<sub>Gi</sub></b>	Gate Input Resistance	1.0		Ω
<b>t<sub>d(on)</sub></b>	<b>Resistive Switching Times</b> V <sub>GS</sub> = 10V, V <sub>DS</sub> = 0.5 • V <sub>DSS</sub> , I <sub>D</sub> = 66A R <sub>G</sub> = 1Ω (External)	44		ns
<b>t<sub>r</sub></b>		9		ns
<b>t<sub>d(off)</sub></b>		72		ns
<b>t<sub>f</sub></b>		8		ns
<b>Q<sub>g(on)</sub></b>	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 0.5 • V <sub>DSS</sub> , I <sub>D</sub> = 66A	250		nC
<b>Q<sub>gs</sub></b>		90		nC
<b>Q<sub>gd</sub></b>		52		nC
<b>R<sub>thJC</sub></b>			0.24 °C/W	
<b>R<sub>thCS</sub></b>		0.15		°C/W

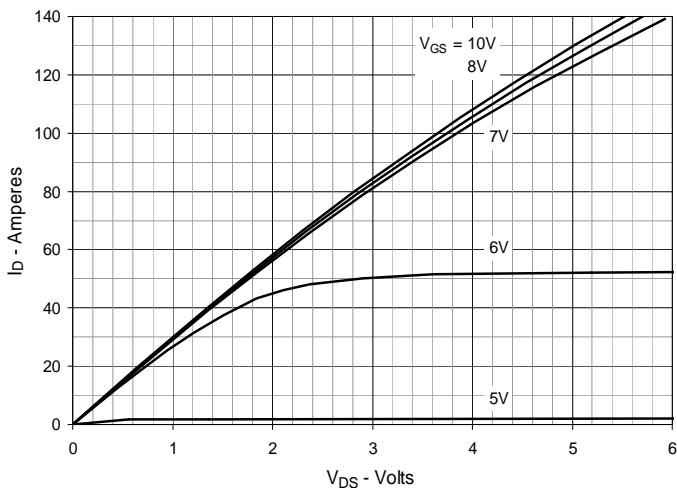
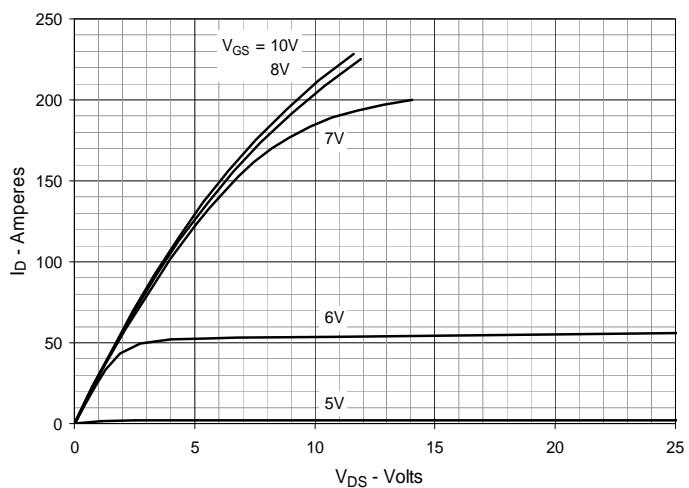
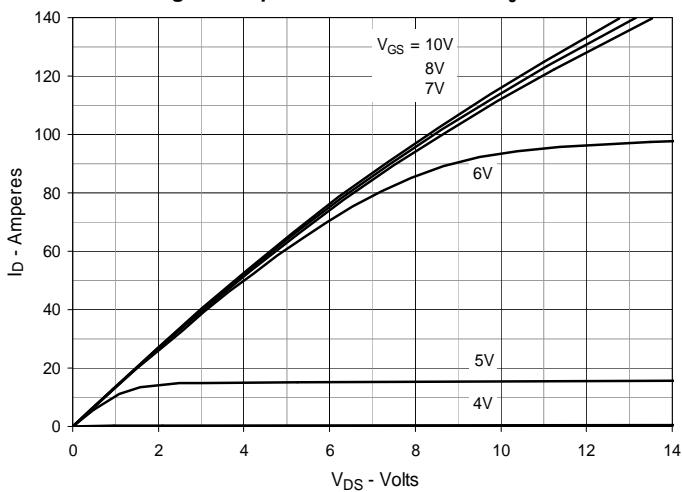
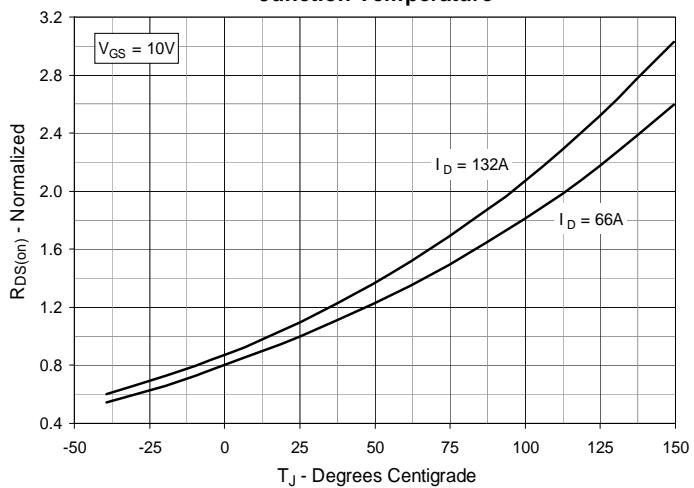
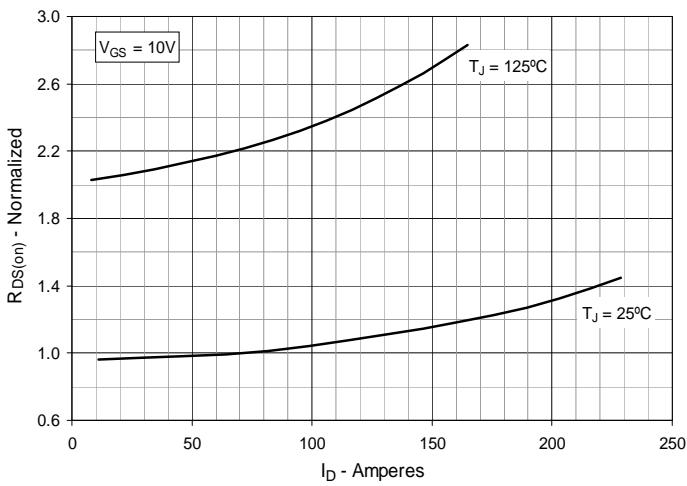
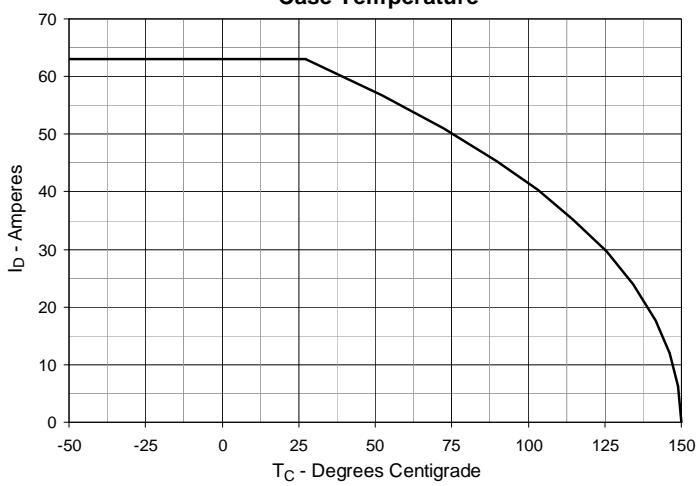
### Source-Drain Diode

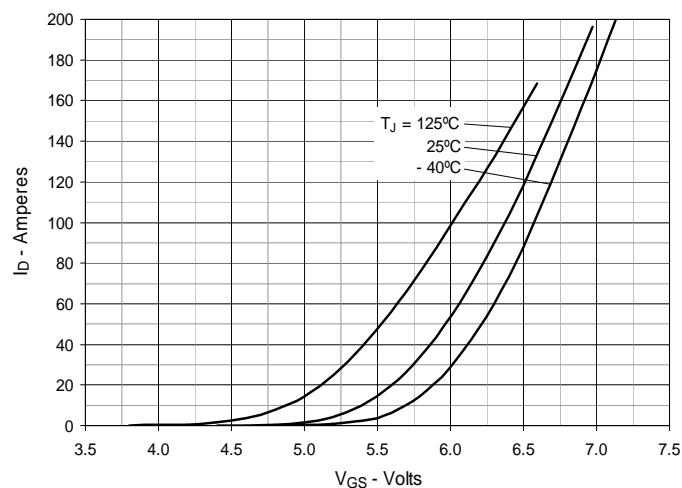
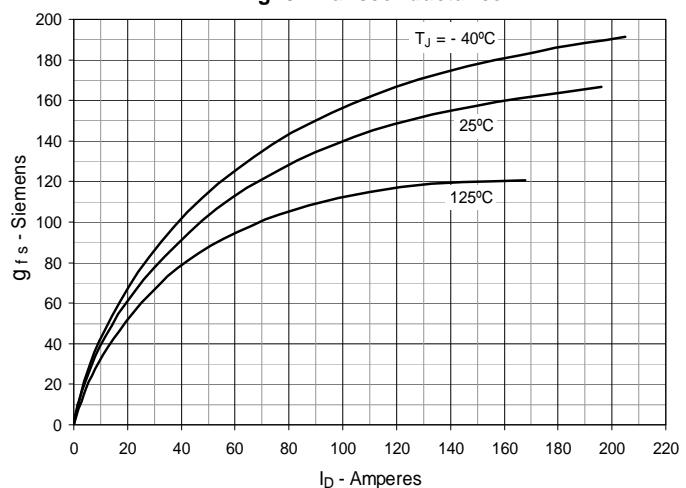
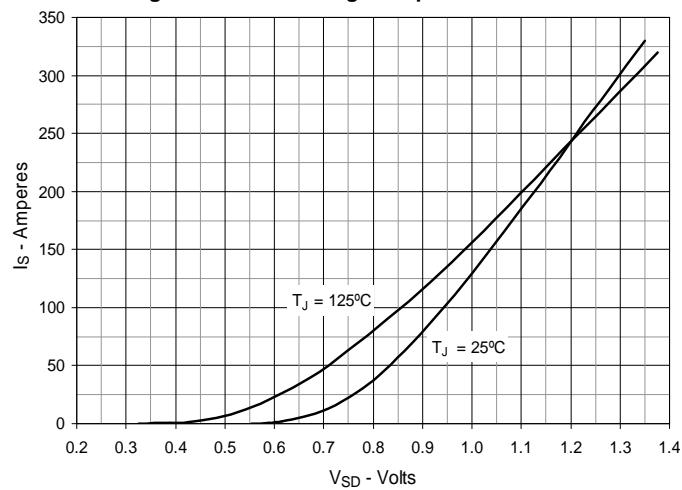
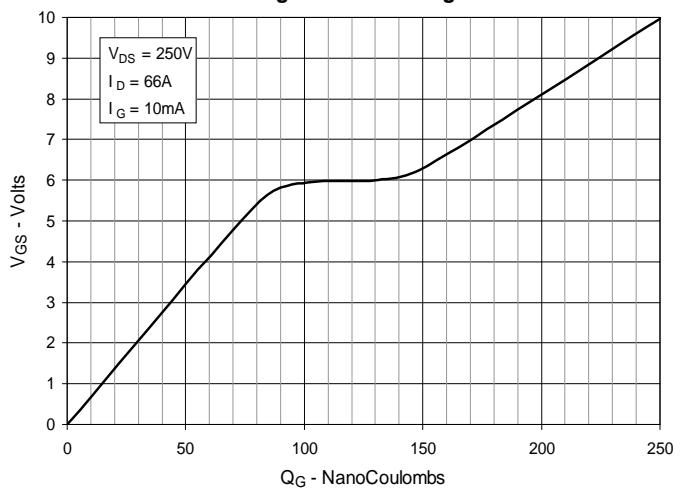
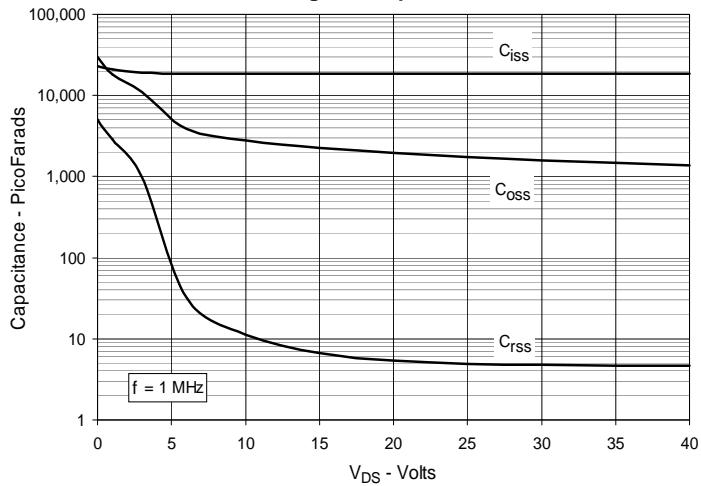
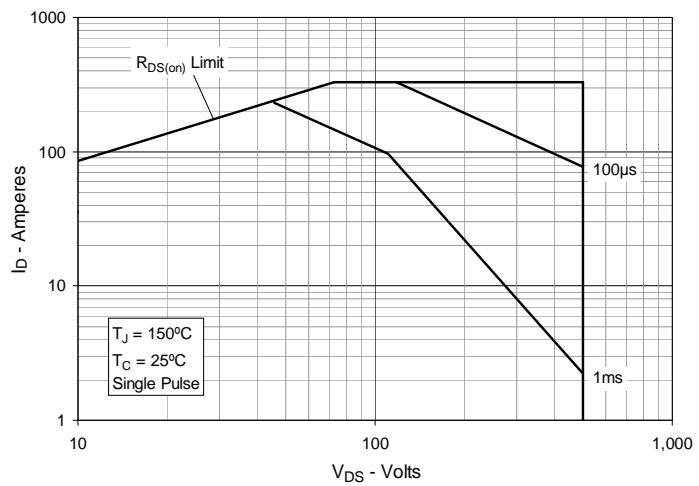
Symbol	Test Conditions (T <sub>J</sub> = 25°C Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
<b>I<sub>s</sub></b>	V <sub>GS</sub> = 0V		132	A
<b>I<sub>SM</sub></b>	Repetitive, Pulse Width Limited by T <sub>JM</sub>		530	A
<b>V<sub>SD</sub></b>	I <sub>F</sub> = 100A, V <sub>GS</sub> = 0V, Note 1		1.5	V
<b>t<sub>rr</sub></b>	I <sub>F</sub> = 66A, -di/dt = 100A/μs V <sub>R</sub> = 100V, V <sub>GS</sub> = 0V		250	ns
<b>Q<sub>RM</sub></b>		1.9		μC
<b>I<sub>RM</sub></b>		16.4		A

Note 1. Pulse test, t ≤ 300μs, duty cycle, d ≤ 2%.

### ISOPLUS264 (IXFL) OUTLINE



**Fig. 1. Output Characteristics @  $T_J = 25^\circ\text{C}$** **Fig. 2. Extended Output Characteristics @  $T_J = 25^\circ\text{C}$** **Fig. 3. Output Characteristics @  $T_J = 125^\circ\text{C}$** **Fig. 4.  $R_{DS(on)}$  Normalized to  $I_D = 66\text{A}$  Value vs. Junction Temperature****Fig. 5.  $R_{DS(on)}$  Normalized to  $I_D = 66\text{A}$  Value vs. Drain Current****Fig. 6. Maximum Drain Current vs. Case Temperature**

**Fig. 7. Input Admittance****Fig. 8. Transconductance****Fig. 9. Forward Voltage Drop of Intrinsic Diode****Fig. 10. Gate Charge****Fig. 11. Capacitance****Fig. 12. Forward-Bias Safe Operating Area**

**Fig. 13. Maximum Transient Thermal Impedance**